



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	V _{(BR)DSS}	R _{DS(ON) max}	I _{D MAX} T _A = +25°C
		$34m\Omega$ @ V_{GS} = $4.5V$	5.1A
Q1 N-Channel	12V	$40 \text{m}\Omega$ @ $V_{GS} = 2.5 \text{V}$	4.7A
		$50m\Omega$ @ V_{GS} = 1.8 V	4.2A
		70 m Ω @ V _{GS} = 1.5V	3.6A
	-12V	$59m\Omega$ @ V_{GS} = -4.5 V	-3.9A
Q2 P-Channel		81mΩ @ V _{GS} = -2.5V	-3.3A
		115mΩ @ V_{GS} = -1.8 V	-2.8A
		$215m\Omega$ @ V_{GS} = -1.5 V	-2.0A

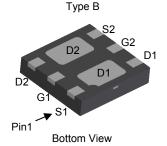
Description

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(ON)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Load Switch
- Power Management Functions
- Portable Power Adaptors





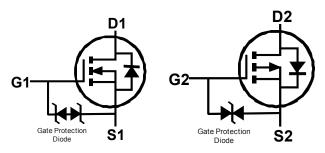
U-DFN2020-6

Features

- Low On-Resistance
- Low Input Capacitance
- Low Profile, 0.6mm Max Height
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: U-DFN2020-6 Type B
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202. Method 208 (e4)
- Terminals Connections: See Diagram Below
- Weight: 0.0065 grams (approximate)



N-CHANNEL MOSFET

P-CHANNEL MOSFET

Internal Schematic

Ordering Information (Note 4)

Part Number	Case	Packaging
DMC1030UFDB -7	U-DFN2020-6 Type B	3000/Tape & Reel
DMC1030UFDB -13	U-DFN2020-6 Type B	10000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



D3 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: A = 2013) M = Month (ex: 9 = September)

Date Code Key

Year	201	2	2013		2014	20	15	2016		2017	2	2018
Code	Z		Α		В	(С	D		Е		F
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Q1 N-CHANNEL	Q2 P-CHANNEL	Units		
Drain-Source Voltage	V_{DSS}	12	-12	V		
Gate-Source Voltage	V _{GSS}	±8	±8	V		
Continuous Prain Current (Note 5) V = 4.5V	Steady State	T _A = +25°C T _A = +70°C	I _D	5.1 4.1	-3.9 -3.1	А
Continuous Drain Current (Note 5) V _{GS} = 4.5V	t < 5s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	6.6 5.3	-5.0 -4.0	Α
Maximum Continuous Body Diode Forward Curre	I _S	2	-1.7	Α		
Pulsed Drain Current (10µs pulse, duty cycle = 1	I _{DM}	35	-25	Α		

Thermal Characteristics

Characteristic		Symbol	Value	Units	
Total Power Dissipation (Note 5)	Steady State	Steady State		W	
Total Fower Dissipation (Note 3)	t < 5s	P_D	1.89	VV	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D.	92		
Thermal Resistance, Junction to Ambient (Note 5)	t < 5s	$R_{\theta JA}$	66	°C/W	
Thermal Resistance, Junction to Case (Note 5)	$R_{\theta JC}$	18			
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C	

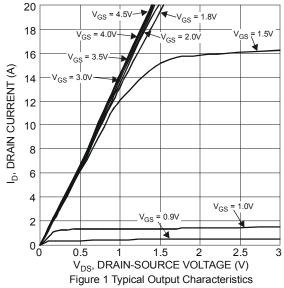
Electrical Characteristics Q1 N-CHANNEL (@ T_A = +25°C, unless otherwise specified.)

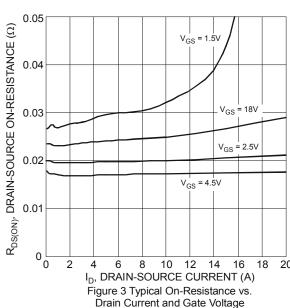
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition			
OFF CHARACTERISTICS (Note 6)									
Drain-Source Breakdown Voltage	BV _{DSS}	12	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$			
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	1.0	μA	$V_{DS} = 12V, V_{GS} = 0V$			
Gate-Source Leakage	I _{GSS}	_	_	±10	μA	V_{GS} = ±8V, V_{DS} = 0V			
ON CHARACTERISTICS (Note 6)	ON CHARACTERISTICS (Note 6)								
Gate Threshold Voltage	$V_{GS(th)}$	0.4	_	1	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$			
			17	34		$V_{GS} = 4.5V$, $I_D = 4.6A$			
Static Drain-Source On-Resistance	D- avanu		20	40	mΩ	$V_{GS} = 2.5V$, $I_D = 4.2A$			
Static Drain-Source Off-Resistance	R _{DS(ON)}	_	24	50	11122	$V_{GS} = 1.8V, I_D = 3.8A$			
		_	28	70		V _{GS} = 1.5V, I _D = 1.5A			
Diode Forward Voltage	V_{SD}	_	0.7	1.2	V	$V_{GS} = 0V, I_S = 4.8A$			
DYNAMIC CHARACTERISTICS (Note 7)	•								
Input Capacitance	Ciss		1003	-	рF	V - CV V - CV			
Output Capacitance	Coss	_	132	_	pF	$V_{DS} = 6V, V_{GS} = 0V,$ f = 1.0MHz			
Reverse Transfer Capacitance	C _{rss}	_	115	_	pF	11 - 1.0WI12			
Gate Resistance	Rg	_	11.3	_	Ω	V_{DS} = 0V, V_{GS} = 0V, f = 1MHz			
Total Gate Charge (V _{GS} = 4.5V)	0	_	12.2	_	nC				
Total Gate Charge (V _{GS} = 8V)	Qg	_	23.1	_	nC	, - 40V I - 6.0A			
Gate-Source Charge	Q_{gs}	_	1.3	_	nC	$V_{DS} = 10V, I_D = 6.8A$			
Gate-Drain Charge	Q_{gd}		1.5	_	nC				
Turn-On Delay Time	t _{D(on)}		4.4	_	ns				
Turn-On Rise Time	t _r	_	7.4	_	ns	$V_{DD} = 6V, V_{GS} = 4.5V,$			
Turn-Off Delay Time	t _{D(off)}	_	18.8	_	ns	$R_L = 1.1\Omega$, $R_G = 1\Omega$			
Turn-Off Fall Time	t _f	_	4.9	_	ns	7			
Body Diode Reverse Recovery Time	trr	_	7.6	_	nS	I _S = 5.4A, dI/dt = 100A/µs			
Body Diode Reverse Recovery Charge	Qrr		0.9		nC	I _S = 5.4A, dI/dt = 100A/μs			

Notes:

- 5. Device mounted on 1" x 1" FR-4 PCB with high coverage 2oz. Copper, single sided.
 6. Short duration pulse test used to minimize self-heating effect.
 7. Guaranteed by design. Not subject to product testing.







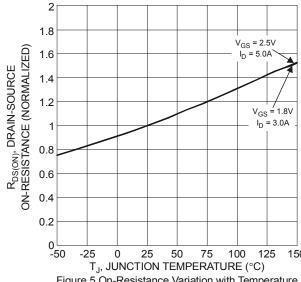
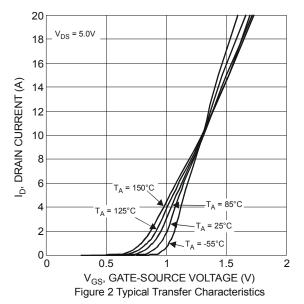
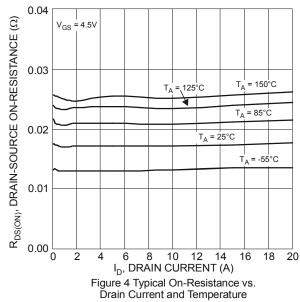
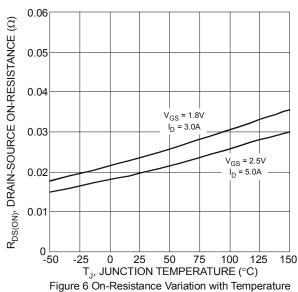


Figure 5 On-Resistance Variation with Temperature









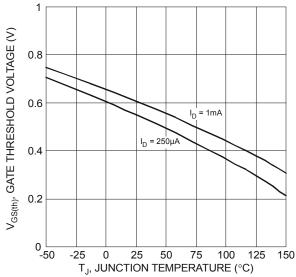
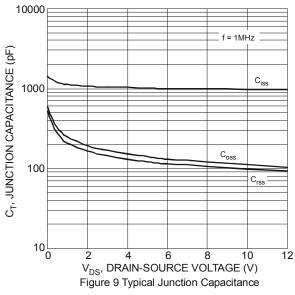
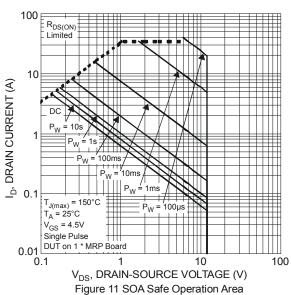
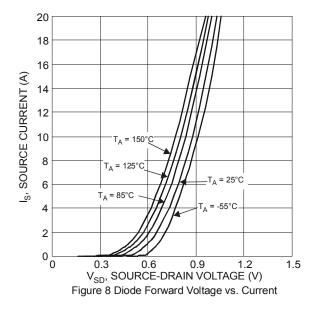
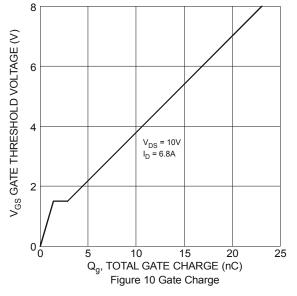


Figure 7 Gate Threshold Variation vs. Ambient Temperature









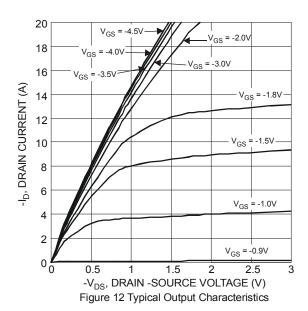


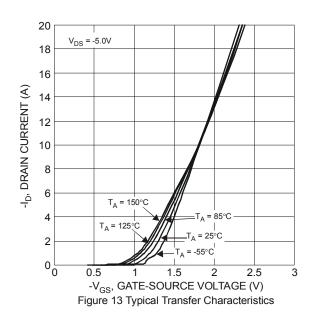
Electrical Characteristics Q2 P-CHANNEL (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition			
OFF CHARACTERISTICS (Note 6)									
Drain-Source Breakdown Voltage	BV _{DSS}	-12	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$			
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_		-1.0	μA	V _{DS} = -12V, V _{GS} = 0V			
Gate-Source Leakage	I _{GSS}	_	_	±10	μA	$V_{GS} = \pm 8V$, $V_{DS} = 0V$			
ON CHARACTERISTICS (Note 6)	ON CHARACTERISTICS (Note 6)								
Gate Threshold Voltage	V _{GS(th)}	-0.4	I	-1	>	$V_{DS} = V_{GS}$, $I_D = -250\mu A$			
		_	37	59		$V_{GS} = -4.5V$, $I_D = -3.6A$			
Static Drain-Source On-Resistance	D	_	48	81	mΩ	$V_{GS} = -2.5V$, $I_D = -3.1A$			
Static Diain-Source On-Resistance	R _{DS(ON)}	_	69	115	11122	$V_{GS} = -1.8V$, $I_D = -2.6A$			
		_	88	215		$V_{GS} = -1.5V, I_D = -0.5A$			
Diode Forward Voltage	V _{SD}	_	-0.7	-1.2	V	V _{GS} = 0V, I _S = -3.7A			
DYNAMIC CHARACTERISTICS (Note 7)						-			
Input Capacitance	C _{iss}	_	1028		pF	V - 0V V - 0V			
Output Capacitance	Coss	_	285	_	pF	$V_{DS} = -6V, V_{GS} = 0V,$ f = 1.0MHz			
Reverse Transfer Capacitance	Crss	_	254	_	pF	1 - 1.000112			
Gate Resistance	R_g	_	19.6	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$			
Total Gate Charge (V _{GS} = -4.5V)	0	_	13	_	nC				
Total Gate Charge (V _{GS} = -8V)	Qg	_	20.8	_	nC), _ 40\/ l _ 4.74			
Gate-Source Charge	Qgs	_	1.8	_	nC	$V_{DS} = -10V$, $I_D = -4.7A$			
Gate-Drain Charge	Q_{gd}	_	4.5	_	nC				
Turn-On Delay Time	t _{D(on)}	_	5.6	_	ns				
Turn-On Rise Time	t _r	_	12.8	_	ns	$V_{DD} = -6V, V_{GS} = -4.5V,$			
Turn-Off Delay Time	t _{D(off)}	_	30.7	_	ns	$R_L = 1.6\Omega$, $R_G = 1\Omega$			
Turn-Off Fall Time	t _f	_	25.4	_	ns	1			
Body Diode Reverse Recovery Time	trr	_	31.6	_	nS	$I_S = -3.6A$, $dI/dt = 100A/\mu s$			
Body Diode Reverse Recovery Charge	Qrr	_	7.8	_	nC	$I_S = -3.6A$, $dI/dt = 100A/\mu s$			

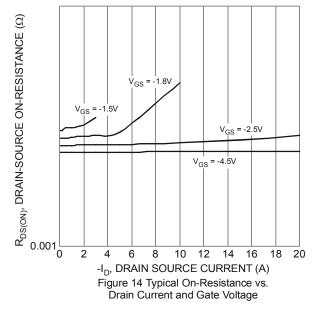
Notes: 6. Short duration pulse test used to minimize self-heating effect.

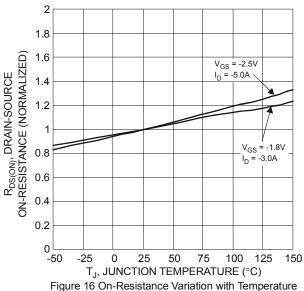
^{7.} Guaranteed by design. Not subject to product testing.











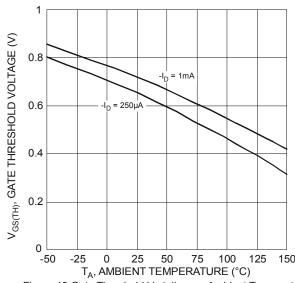
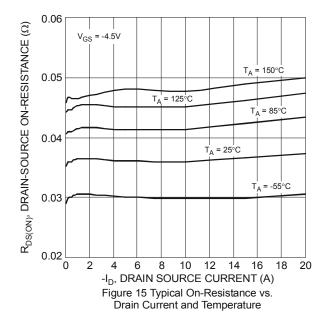
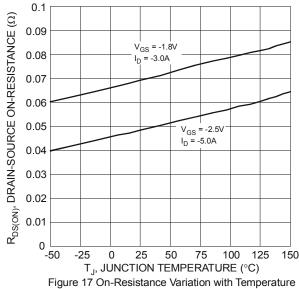


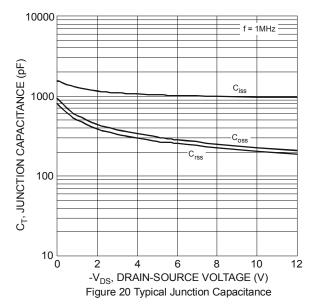
Figure 18 Gate Threshold Variation vs. Ambient Temperature

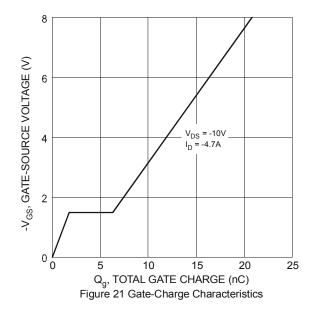


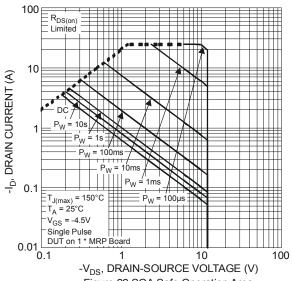


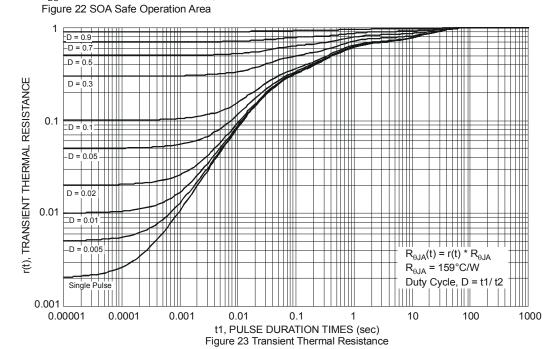
20 18 16 -I_S, SOURCE CURRENT (A) 14 12 10 T_A= 150°C 8 6 4 -55°C 2 0 0 0.3 0.6 0.9 1.2 1.5 -V_{SD}, SOURCE-DRAIN VOLTAGE (V) Figure 19 Diode Forward Voltage vs. Current







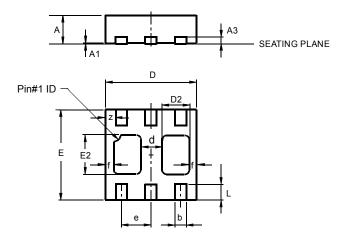






Package Outline Dimensions

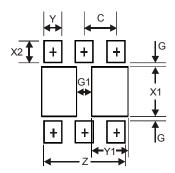
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



U-DFN2020-6								
	Type B							
Dim	Min	Max	Тур					
Α	0.545	0.605	0.575					
A1	0	0.05	0.02					
A3		_	0.13					
b	0.20	0.30	0.25					
D	1.95	2.075	2.00					
d		_	0.45					
D2	0.50	0.70	0.60					
е	_	_	0.65					
E	1.95	2.075	2.00					
E2	0.90	1.10	1.00					
f			0.15					
L	0.25	0.35	0.30					
z		_	0.225					
All	Dimens	ions in	mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	1.67
G	0.20
G1	0.40
X1	1.0
X2	0.45
Υ	0.37
Y1	0.70
С	0.65



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